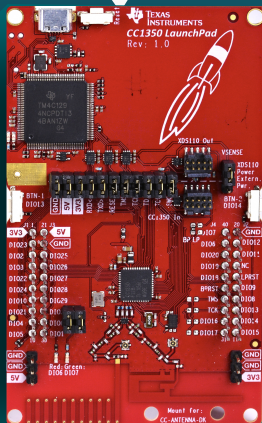




CC1350 LaunchPad™

// wireless microcontroller development kit for rapid prototyping.

LAUNCHXL-CC1350



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